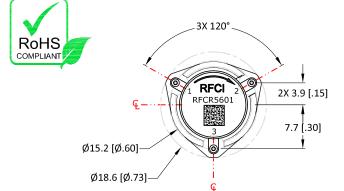
DWG. NO.

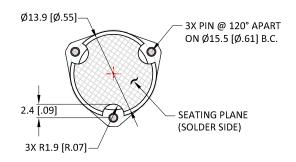
CR5601-OS

SHT REV
1 B

THIS DRAWING HAS BEEN GENERATED BY A CAD SYSTEM. CHANGES SHALL ONLY BE INCORPORATED AS DIRECTED BY THE DESIGN ACTIVITY.

REVISIONS						
REV.	DESCRIPTION	ECO	DATE	APPROVED		
В	REVISED MECHANICAL HOUSING BODY	18-007	10/31/18	P.T		





Port (3)-(1) Finish:

Ø16.3 [Ø.64]

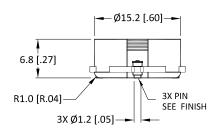
Ø6.8 [Ø.27]

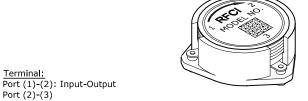
Ø13.1 [Ø.52]

Ø10.0 [Ø.39]

3X PIN

CONTACT PAD





Specifications

Parameter	Minimum	Typical	Maximum
Frequency Range (MHz)	1930		1995
Insertion Loss: In-Out (dB)		< .22	.30
Isolation: Out-In (dB)	20	> 23	
Return Loss (dB)	20	> 23	
FWD IMD: 2T at 37W per T		70	
5MHz Spacing (dBc)			

Notes:

- 1. Typical Values Represent Performance @ +23 °C.
- S-Parameters to be measured by connecting Port 1 and 2 to VNA, and Port 3 to Load with return loss 30dB or higher

Power & Temperature Ratings

Parameter	Maximum	
Forward PWR Peak/AVG	500/100 Watts	
Reverse Power CW	80 Watts	
Operating Temperature	-40 to +85° C	
Storage Temperature	-50 to +125° C	

Permanent damage to the Device or reduce reliability if exceeding any of the limits.

Port (1),(2)and (3): DC connected and floating as the only ground connection.

Body Housing: Silver plated Pin: Gold plated Coplanarity specification: 0.10 [.004] MAX.

Recommended Footprint Copper-Solder Mask Pattern

SolderMask Pattern

3X R2.1 [R.08] CLEARANCE AROUND PIN

COPPER CLAD

ARFA

Ø.5 [Ø.02] Thru Via

Ø14.2 [Ø.56]

The Land Pattern should be with good thermal conductivity

CW SMD CIRCULATOR MODEL: RFCR5601

